

UPPER TOP PLATE AND SUBSTRATE PROCESSING APPARATUS

ABSTRACT

5 An upper top plate is an upper top plate arranged at
an upper part of a chamber, and the upper top plate
includes a base, an upper electrode that is arranged on a
lower surface side of the base, and a thermally conductive
medium that is filled in a heat transfer space being
10 provided between a lower surface of the base and an upper
surface of the upper electrode and being surrounded by a
sealing member, in which a buffer space communicating with
the heat transfer space is formed on the lower surface of
the base in contact with the heat transfer space, and the
15 thermally conductive medium is also partially filled in the
buffer space.

Figure 3